

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

**TC74ACT161P, TC74ACT161F, TC74ACT161FN**  
**TC74ACT163P, TC74ACT163F, TC74ACT163FN**

**SYNCHRONOUS PRESETTABLE 4 - BIT BINARY COUNTER**  
 TC74ACT161P/F/FN ASYNCHRONOUS CLEAR  
 TC74ACT163P/F/FN SYNCHRONOUS CLEAR

(Note) The JEDEC SOP (FN) is not available in Japan.

The TC74ACT161 and T163 are advanced high speed CMOS SYNCHRONOUS PRESETTABLE 4 BIT BINARY COUNTERs fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These devices may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

The CK input is active on the rising edge. Both  $\overline{LOAD}$  and  $\overline{CLR}$  inputs are active on low logic level.

Presetting of these IC's is synchronous to the rising edge of CK.

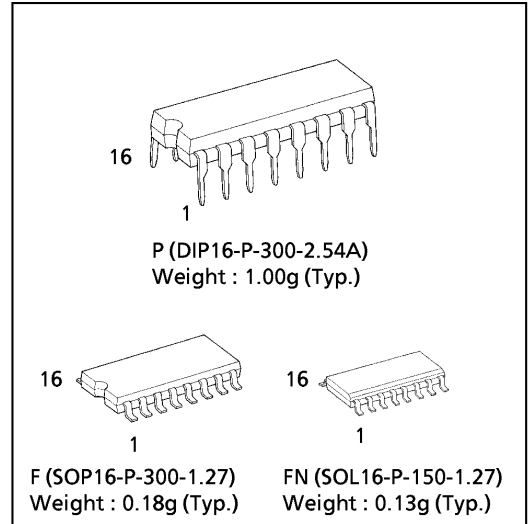
The clear function of the TC74ACT163 is synchronous to CK, while the TC74ACT161 are cleared asynchronously.

Two enable inputs (ENP and ENT) and CARRY OUTPUT are provided to enable easy cascading of counters, which facilitates easy implementation of n-bit counters without using external gates.

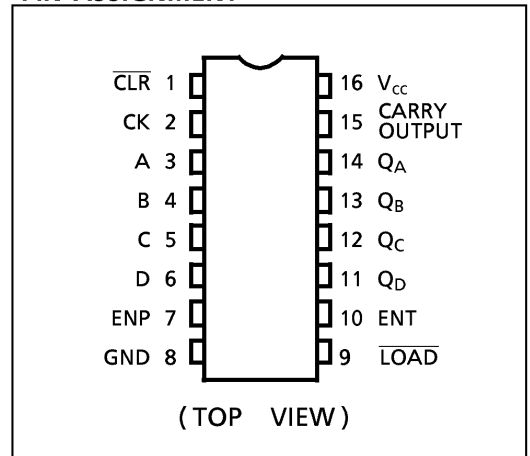
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

**FEATURES :**

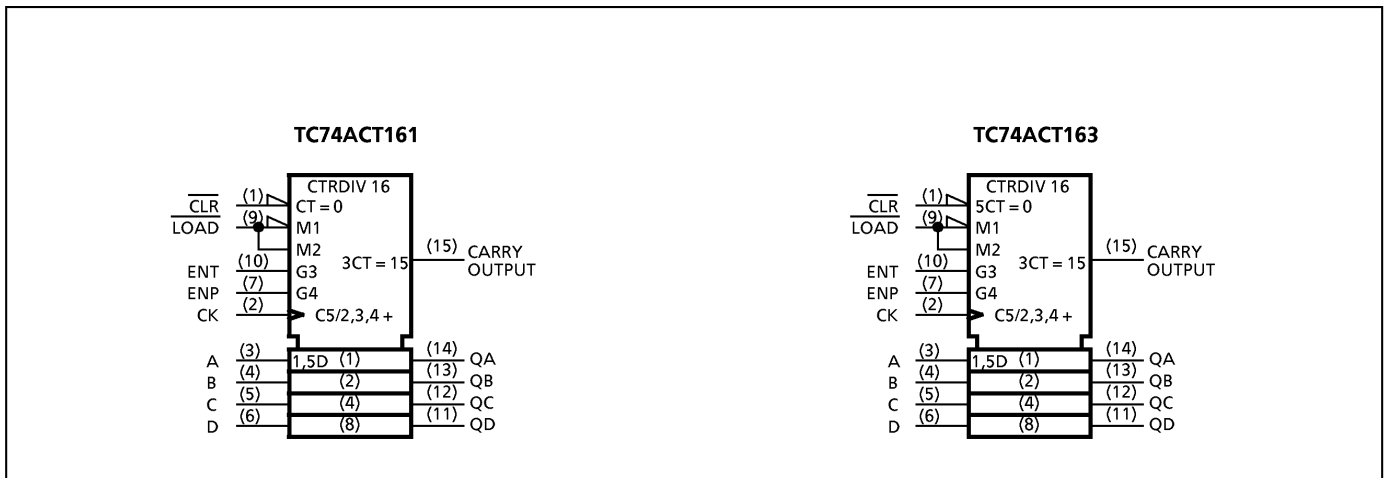
- High Speed..... $f_{MAX} = 110\text{MHz}(\text{typ.})$  at  $V_{CC} = 5\text{V}$
- Low Power Dissipation..... $I_{CC} = 8\mu\text{A}(\text{Max.})$  at  $T_a = 25^\circ\text{C}$
- Compatible with TTL outputs ...  $V_{IL} = 0.8\text{V}(\text{Max.})$   
 $V_{IH} = 2.0\text{V}(\text{Min.})$
- Symmetrical Output Impedance...  $|I_{OH}| = I_{OL} = 24\text{mA}(\text{Min.})$   
 Capability of driving  $50\Omega$  transmission lines.
- Balanced Propagation Delays..... $t_{PLH} \approx t_{PHL}$
- Pin and Function Compatible with 74F161/163



**PIN ASSIGNMENT**



**IEC LOGIC SYMBOL**

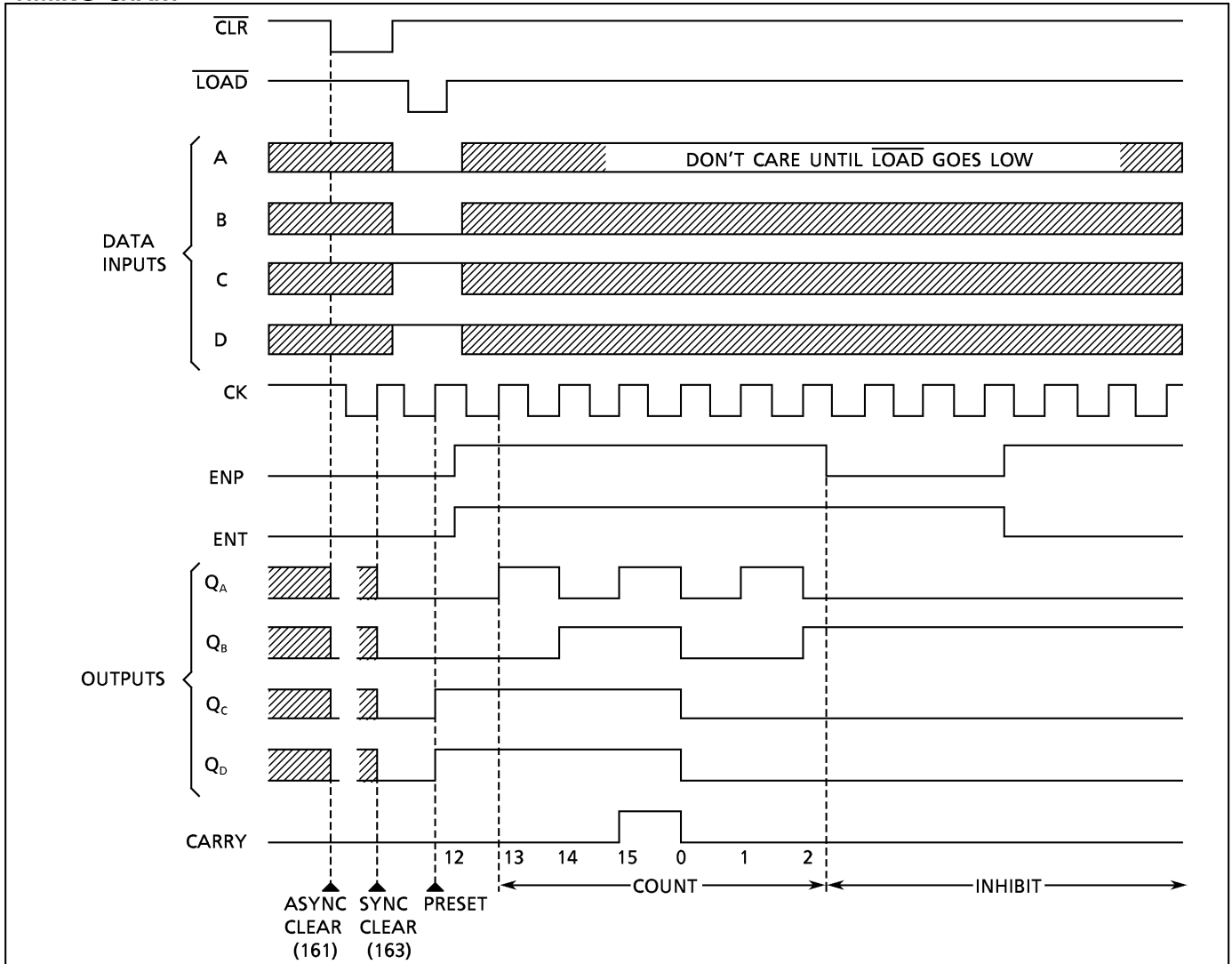


**TRUTH TABLE**

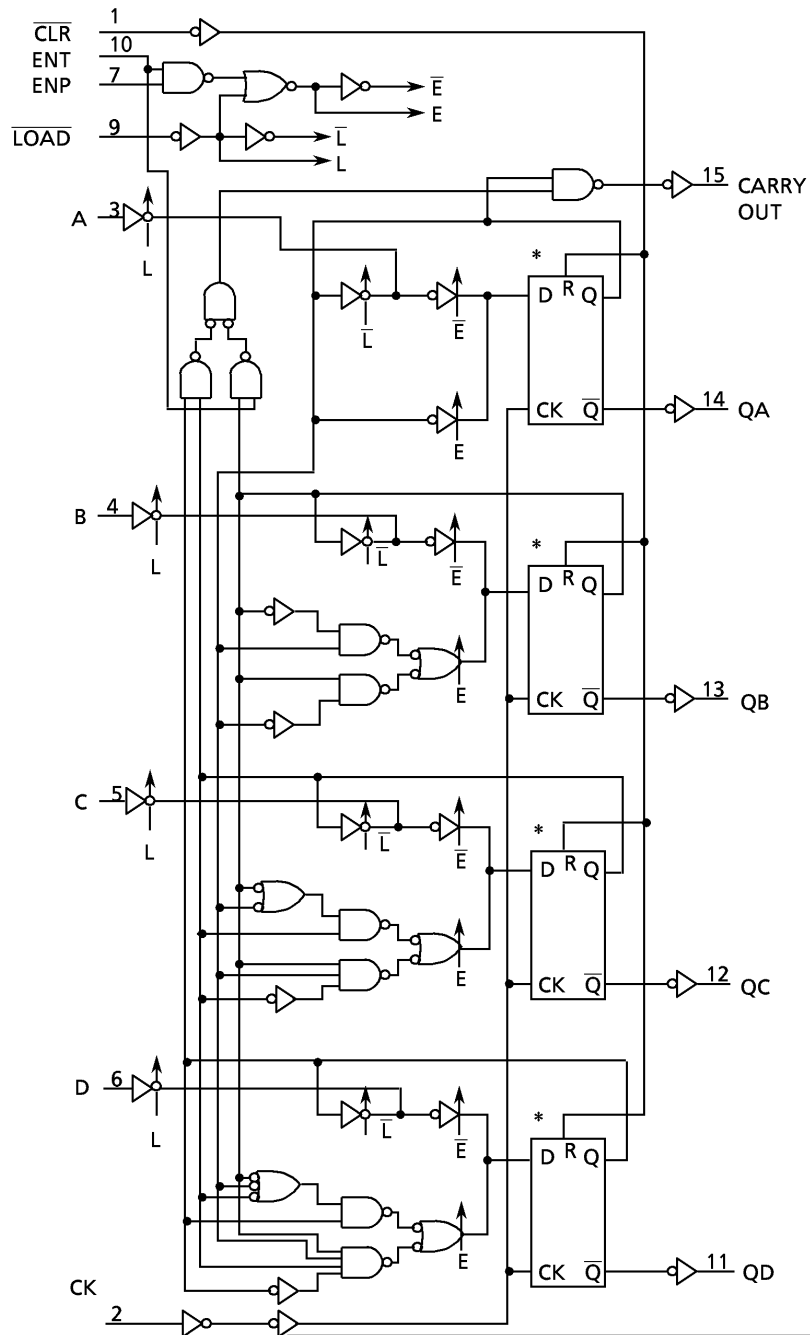
INPUTS							OUTPUTS				FUNCTION
CLR (161)	CLR (163)	LOAD	ENP	ENT	CK (161)	CK (163)	QA	QB	QC	QD	
L	L	X	X	X	X	$\uparrow$	L	L	L	L	RESET TO "0"
H	H	L	X	X	$\uparrow$	$\uparrow$	A	B	C	D	PRESET DATA
H	H	H	X	L	$\uparrow$	$\uparrow$	NO CHANGE				NO COUNT
H	H	H	L	X	$\uparrow$	$\uparrow$	NO CHANGE				NO COUNT
H	H	H	H	H	$\uparrow$	$\uparrow$	COUNT UP				COUNT
H	X	X	X	X	$\downarrow$	$\downarrow$	NO CHANGE				NO COUNT

Note X : Don't Care  
 A, B, C, D : Logic Level of Data Inputs  
 Carry : CARRY = ENT · QA · QB · QC · QD

**TIMING CHART**



SYSTEM DIAGRAM



\* TRUTH TABLE OF INTERNAL F/F

TC74ACT161					TC74ACT163				
D	CK	R	Q	$\bar{Q}$	D	CK	R	Q	$\bar{Q}$
X	X	H	L	H	X	$\uparrow$	H	L	H
L	$\uparrow$	L	L	H	L	$\uparrow$	L	L	H
H	$\uparrow$	L	H	L	X	$\uparrow$	L	H	L
X	$\downarrow$	L	NO CHANGE		X	$\downarrow$	L	NO CHANGE	

X : Don't Care

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V <sub>CC</sub>	-0.5~7.0	V
DC Input Voltage	V <sub>IN</sub>	-0.5~V <sub>CC</sub> +0.5	V
DC Output Voltage	V <sub>OUT</sub>	-0.5~V <sub>CC</sub> +0.5	V
Input Diode Current	I <sub>IK</sub>	±20	mA
Output Diode Current	I <sub>OK</sub>	±50	mA
DC Output Current	I <sub>OUT</sub>	±50	mA
DC V <sub>CC</sub> /Ground Current	I <sub>CC</sub>	±125	mA
Power Dissipation	P <sub>D</sub>	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T <sub>stg</sub>	-65~150	°C

\*500mW in the range of Ta = -40°C~65°C. From Ta = 65°C to 85°C a derating factor of -10mW/°C should be applied up to 300mW.

**RECOMMENDED OPERATING CONDITIONS**

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V <sub>CC</sub>	4.5~5.5	V
Input Voltage	V <sub>IN</sub>	0~V <sub>CC</sub>	V
Output Voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	V
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Input Rise and Fall Time	dt/dV	0~10	ns/V

**DC ELECTRICAL CHARACTERISTICS**

PARAMETER	SYMBOL	TEST CONDITION	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40~85°C		UNIT	
				MIN.	TYP.	MAX.	MIN.	MAX.		
High - Level Input Voltage	V <sub>IH</sub>		4.5 } 5.5	2.0	—	—	2.0	—	V	
Low - Level Input Voltage	V <sub>IL</sub>		4.5 } 5.5	—	—	0.8	—	0.8	V	
High - Level Output Voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50μA	4.5	4.4	4.5	—	4.4	—	V
			I <sub>OH</sub> = -24mA	4.5	3.94	—	—	3.80	—	
			I <sub>OH</sub> = -75mA*	5.5	—	—	—	3.85	—	
Low - Level Output Voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50μA	4.5	—	0.0	0.1	—	0.1	V
			I <sub>OL</sub> = 24mA	4.5	—	—	0.36	—	0.44	
			I <sub>OL</sub> = 75mA*	5.5	—	—	—	—	1.65	
Input Leakage Current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5	—	—	±0.1	—	±1.0	μA	
Quiescent Supply Current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5	—	—	8.0	—	80.0		
		I <sub>C</sub>	PER INPUT : V <sub>IN</sub> = 3.4V OTHER INPUT : V <sub>CC</sub> or GND	5.5	—	—	1.35	—	1.5	mA

\* : This spec indicates the capability of driving 50Ω transmission lines.  
One output should be tested at a time for a 10ms maximum duration.

TIMING REQUIREMENTS (Input  $t_r = t_f = 3\text{ns}$ )

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C		Ta = -40~85°C		UNIT
			V <sub>CC</sub> (V)	LIMIT	LIMIT	LIMIT	
Minimum Pulse Width (CK)	$t_{W(L)}$ $t_{W(H)}$	Fig .1	5.0 ± 0.5	5.0	5.0	5.0	ns
Minimum Pulse Width ( $\overline{\text{CLR}}$ )*	$t_{W(L)}$	Fig .4	5.0 ± 0.5	5.0	5.0	5.0	
Minimum Pulse Width (LOAD, ENP, ENT)	$t_s$	Fig .2, 3	5.0 ± 0.5	6.0	6.0	6.0	
Minimum Set - up Time (A, B, C, D)	$t_s$	Fig .2	5.0 ± 0.5	4.0	4.0	4.0	
Minimum Set - up Time ( $\overline{\text{CLR}}$ )**	$t_s$	Fig .5	5.0 ± 0.5	3.0	3.0	3.0	
Minimum Hold Time (LOAD, ENP, ENT)	$t_h$	Fig .2, 3	5.0 ± 0.5	1.0	1.0	1.0	
Minimum Hold Time (A, B, C, D)	$t_h$	Fig .2	5.0 ± 0.5	2.0	2.0	2.0	
Minimum Hold Time ( $\overline{\text{CLR}}$ )**	$t_h$	Fig .5	5.0 ± 0.5	2.0	2.0	2.0	
Minimum Removal Time ( $\overline{\text{CLR}}$ )*	$t_{rem}$	Fig .4	5.0 ± 0.5	1.0	1.0	1.0	

\* for TC74ACT161 only

\*\* for TC74ACT163 only

**AC ELECTRICAL CHARACTERISTICS (CL = 50pF, RL = 500 Ω, Input tr = tf = 3ns)**

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C			Ta = -40~85°C		UNIT	
			V <sub>CC</sub> (V)	MIN.	TYP.	MAX.	MIN.		MAX.
Propagation Delay Time (CK-Q)	t <sub>pLH</sub> t <sub>pHL</sub>	Fig.1	5.0 ± 0.5	—	7.2	10.5	1.0	12.0	ns
Propagation Delay Time (CK-CARRY, Count Mode)	t <sub>pLH</sub> t <sub>pHL</sub>	Fig.1	5.0 ± 0.5	—	8.5	13.0	1.0	15.0	
Propagation Delay Time (CK-CARRY, Preset Mode)	t <sub>pLH</sub> t <sub>pHL</sub>	Fig.2	5.0 ± 0.5	—	9.7	15.0	1.0	17.0	
Propagation Delay Time (ENT-CARRY)	t <sub>pLH</sub> t <sub>pHL</sub>	Fig.6	5.0 ± 0.5	—	6.6	10.0	1.0	11.5	
Propagation Delay Time (CLR-Q)*	t <sub>pHL</sub>	Fig.4	5.0 ± 0.5	—	6.3	10.0	1.0	11.5	
Propagation Delay Time (CLR-CARRY)*	t <sub>pHL</sub>	Fig.4	5.0 ± 0.5	—	7.7	12.3	1.0	14.0	
Maximum Clock Frequency	f <sub>MAX</sub>		5.0 ± 0.5	70	100	—	60	—	MHz
Input Capacitance	C <sub>IN</sub>			—	5	10	—	10	pF
Power Dissipation Capacitance	C <sub>PD</sub> (1)			—	46	—	—	—	

Note (1) C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr.}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

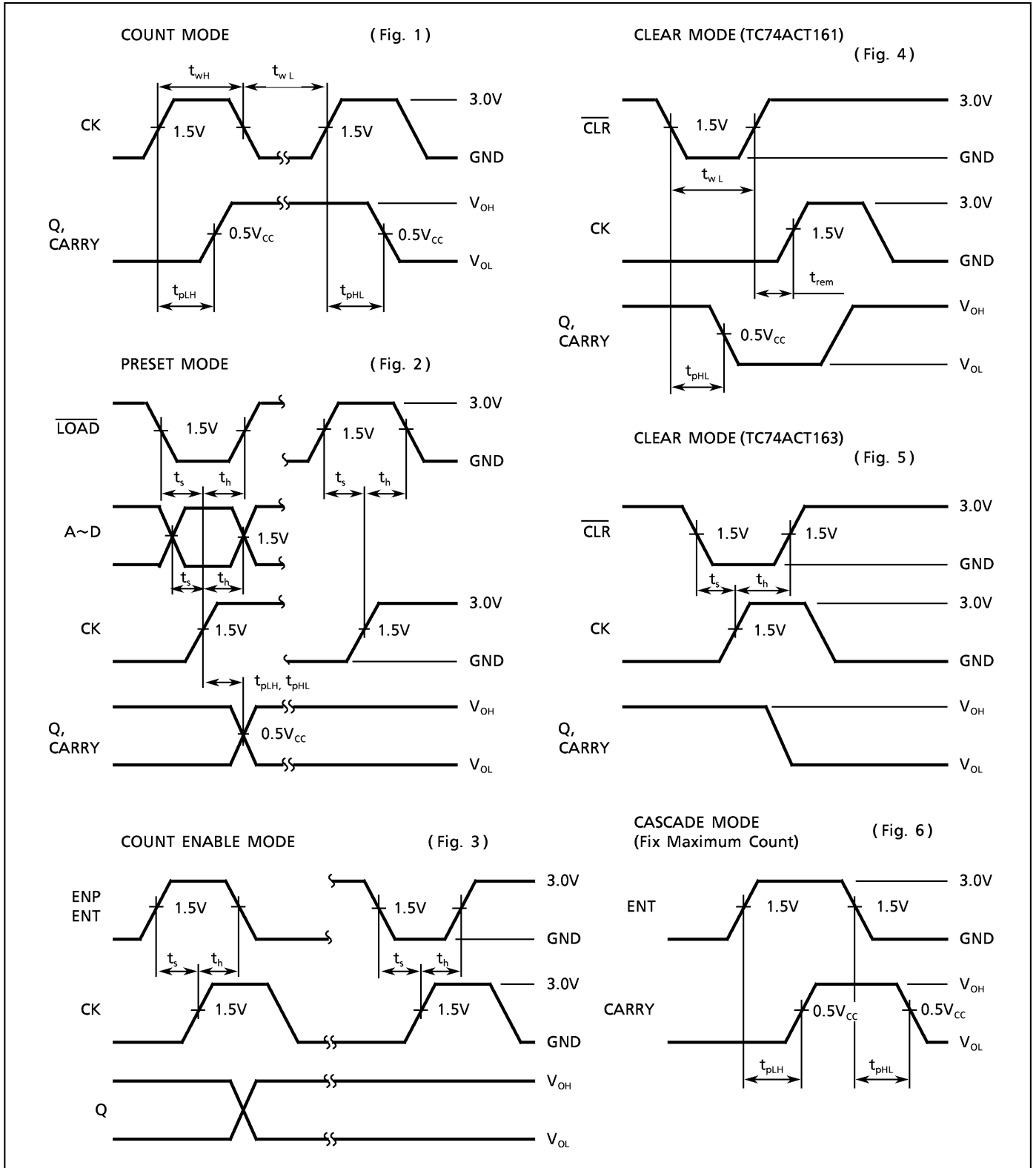
When the outputs drive a capacitive load, total current consumption is the sum of C<sub>PD</sub>, and ΔI<sub>CC</sub> which is obtained from the following formula:

$$\Delta I_{CC} = f_{CK} \cdot V_{CC} \left( \frac{C_{QA}}{2} + \frac{C_{QB}}{4} + \frac{C_{QC}}{8} + \frac{C_{QD}}{16} + \frac{C_{CO}}{16} \right)$$

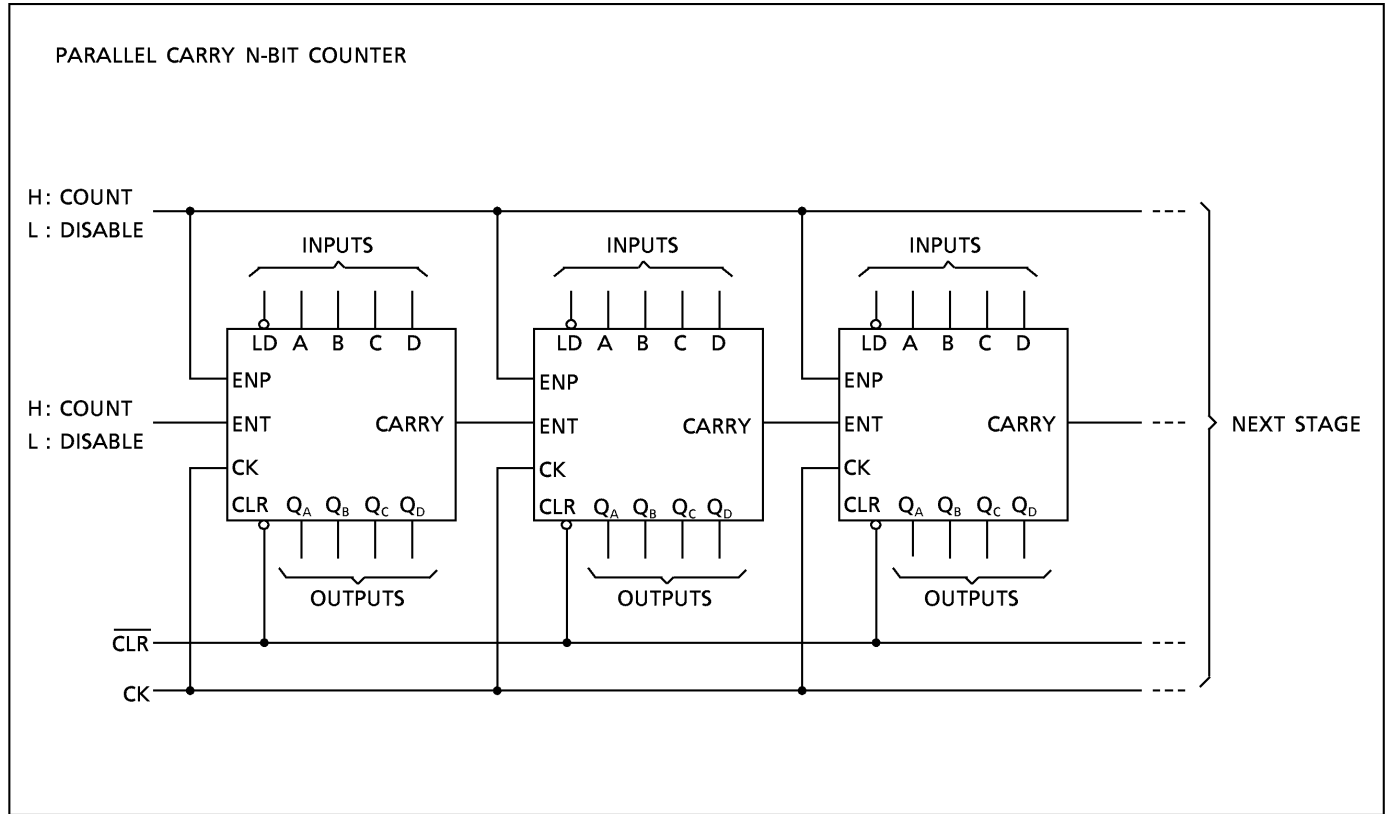
C<sub>QA</sub>~C<sub>QD</sub> and C<sub>CO</sub> are the capacitances at QA~QD and CARRY OUT, respectively.  
f<sub>CK</sub> is the input frequency of the CK.

(2) \* for TC74ACT161 only

SWITCHING CHARACTERISTICS TEST WAVEFORM



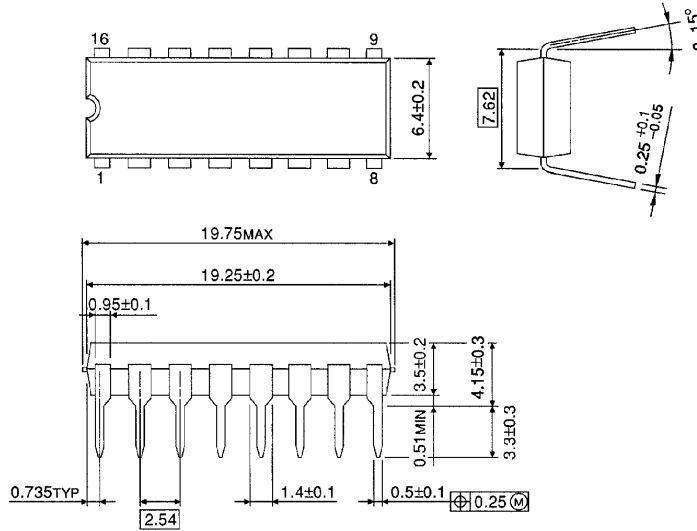
**TYPICAL APPLICATION**





**DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A)**

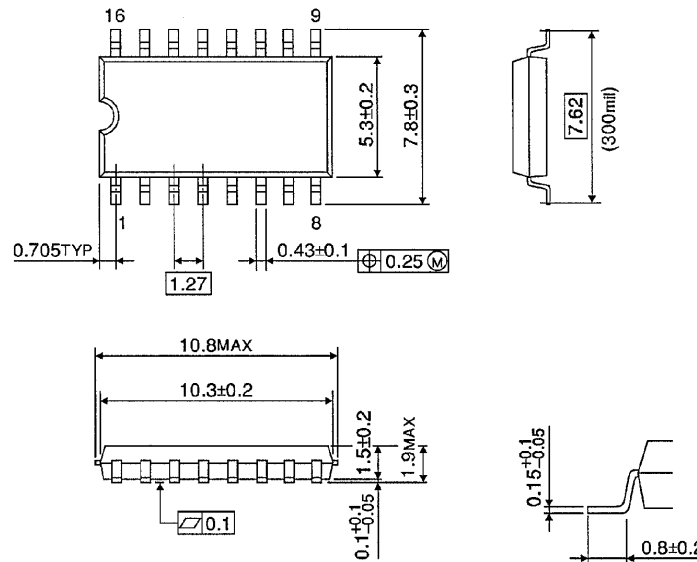
Unit in mm



Weight : 1.00g (Typ.)

**SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27)**

Unit in mm

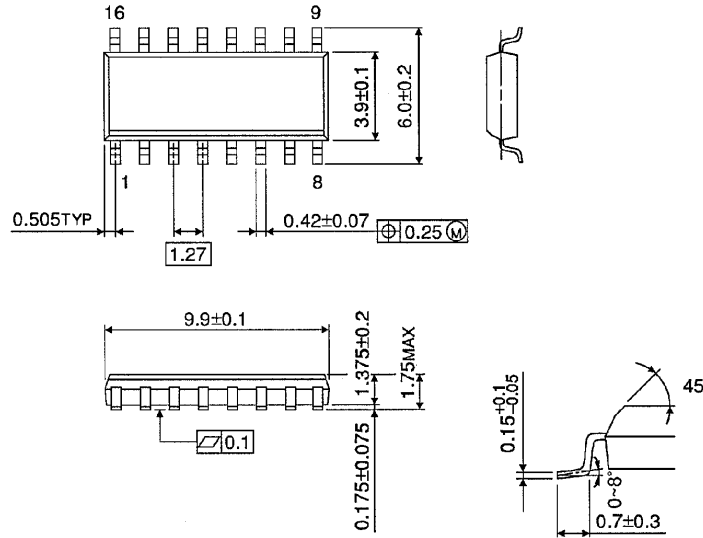


Weight : 0.18g (Typ.)

**SOP 16PIN (150mil BODY) PACKAGE DIMENSIONS (SOL16-P-150 -1.27)**

Unit in mm

(Note) This package is not available in Japan.



Weight : 0.13g (Typ.)

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